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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









Low Loss IGBT in TrenchStop® and Fieldstop technology

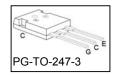
- Best in class TO247
- Short circuit withstand time 10 µs
- Designed for:
 - Frequency Converters
 - Uninterrupted Power Supply
- TrenchStop® and Fieldstop technology for 1200 V applications offers:
 - very tight parameter distribution
 - high ruggedness, temperature stable behavior
- NPT technology offers easy parallel switching capability due to positive temperature coefficient in V_{CE(sat)}
- Low EMI
- Low Gate Charge
- Qualified according to JEDEC¹ for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models: http://www.infineon.com/igbt/

| Туре | V _{CE} | Ic | V _{CE(sat),Tj=25°C} | $T_{\rm j,max}$ | Marking Code | Package |
|-----------|------------------------|-----|------------------------------|-----------------|--------------|-------------|
| IGW60T120 | 1200V | 60A | 1.7V | 150°C | G60T120 | PG-TO-247-3 |

Maximum Ratings

| Parameter | Symbol | Value | Unit |
|---|--------------------|---------|------|
| Collector-emitter voltage | V _{CE} | 1200 | V |
| DC collector current | I _C | | Α |
| $T_{\rm C}$ = 25°C | | 100 | |
| $T_{\rm C}$ = 90°C | | 60 | |
| Pulsed collector current, t_p limited by T_{jmax} | I _{Cpuls} | 150 | |
| Turn off safe operating area | - | 150 | |
| $V_{CE} \le 1200 \text{V}, \ T_{j} \le 150 ^{\circ} \text{C}$ | | | |
| Gate-emitter voltage | V_{GE} | ±20 | V |
| Short circuit withstand time ²⁾ | tsc | 10 | μS |
| $V_{\rm GE}$ = 15V, $V_{\rm CC} \le$ 1200V, $T_{\rm j} \le$ 150°C | | | |
| Power dissipation | P _{tot} | 375 | W |
| $T_{\rm C}$ = 25°C | | | |
| Operating junction temperature | T _j | -40+150 | °C |
| Storage temperature | $T_{\rm stg}$ | -55+150 | |
| Soldering temperature, 1.6mm (0.063 in.) from case for 10s | - | 260 | |





¹ J-STD-020 and JESD-022 ²⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



Thermal Resistance

| Parameter | Symbol | Conditions | Max. Value | Unit |
|--------------------------|------------|------------|------------|------|
| Characteristic | | | | |
| IGBT thermal resistance, | R_{thJC} | | 0.33 | K/W |
| junction – case | | | | |
| Thermal resistance, | R_{thJA} | | 40 | |
| junction – ambient | | | | |

Electrical Characteristic, at T_j = 25 °C, unless otherwise specified

| Danamatan | Current ed | Conditions | Value | | | 11!4 |
|--------------------------------------|-------------------|---|-------|------|------|------|
| Parameter | Symbol | | min. | typ. | max. | Unit |
| Static Characteristic | • | | | • | • | |
| Collector-emitter breakdown voltage | $V_{(BR)CES}$ | V_{GE} =0V, I_{C} =3.0mA | 1200 | - | - | V |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | $V_{\rm GE} = 15 \text{V}, I_{\rm C} = 60 \text{A}$ | | | | |
| | | <i>T</i> _j =25°C | - | 1.9 | 2.4 | |
| | | T _j =125°C | - | 2.1 | - | |
| | | T _j =150°C | - | 2.3 | - | |
| Gate-emitter threshold voltage | $V_{\rm GE(th)}$ | $I_{\rm C}$ =2.0mA, $V_{\rm CE}$ = $V_{\rm GE}$ | 5.0 | 5.8 | 6.5 | |
| Zero gate voltage collector current | I _{CES} | V _{CE} =1200V, V _{GE} =0V | | | | mA |
| | | <i>T</i> _j =25°C | - | - | 0.6 | |
| | | <i>T</i> _j =150°C | - | - | 6.0 | |
| Gate-emitter leakage current | I _{GES} | $V_{CE} = 0V, V_{GE} = 20V$ | - | - | 600 | nA |
| Transconductance | g _{fs} | V _{CE} =20V, I _C =60A | - | 30 | - | S |
| Integrated gate resistor | R _{Gint} | | | 4 | | Ω |

Dynamic Characteristic

| Dynamic Gnaractorione | | | | | | |
|---|-------------------|--|---|------|---|----|
| Input capacitance | Ciss | V _{CE} =25V, | - | 3700 | - | pF |
| Output capacitance | Coss | $V_{GE}=0V$, | - | 180 | - | |
| Reverse transfer capacitance | Crss | f=1MHz | - | 150 | - | |
| Gate charge | Q _{Gate} | $V_{\rm CC}$ =960V, $I_{\rm C}$ =60A | - | 280 | - | nC |
| | | V _{GE} =15V | | | | |
| Internal emitter inductance | LE | | - | 13 | - | nΗ |
| measured 5mm (0.197 in.) from case | | | | | | |
| Short circuit collector current ¹⁾ | $I_{C(SC)}$ | $V_{\text{GE}} = 15 \text{V}, t_{\text{SC}} \le 10 \mu\text{s}$ $V_{\text{CC}} = 600 \text{V},$ $T_{\text{j}} = 25 ^{\circ}\text{C}$ | - | 300 | - | A |

¹⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.

Rev. 2.4 Nov. 09



TrenchStop® Series

Switching Characteristic, Inductive Load, at T_j =25 °C

| Davamatar | Symbol | Conditions | Value | | | I I m i 4 |
|------------------------|------------------|---|-------|------|------|-----------|
| Parameter | | | min. | typ. | max. | Unit |
| IGBT Characteristic | · | | | | | |
| Turn-on delay time | $t_{d(on)}$ | <i>T</i> _j =25°C, | - | 50 | - | ns |
| Rise time | t _r | V_{CC} =600V, I_{C} =60A, V_{GE} =0/15V, R_{G} =10 Ω , L_{σ}^{2} =180nH, C_{σ}^{2} =39pF Energy losses include "tail" and diode reverse recovery. | - | 44 | - | |
| Turn-off delay time | $t_{d(off)}$ | | - | 480 | - | |
| Fall time | t _f | | - | 80 | - | |
| Turn-on energy | Eon | | - | 4.3 | - | mJ |
| Turn-off energy | E _{off} | | - | 5.2 | - | |
| Total switching energy | Ets | | - | 9.5 | - | |

Switching Characteristic, Inductive Load, at T_j =150 °C

| Parameter | Symbol | Conditions | Value | | | Unit |
|------------------------|------------------|--|-------|------|------|------|
| | | | min. | typ. | max. | Unit |
| IGBT Characteristic | | | | | | |
| Turn-on delay time | $t_{d(on)}$ | T _j =150°C | - | 50 | - | ns |
| Rise time | t _r | V_{CC} =600V, I_{C} =60A, V_{GE} =0/15V, R_{G} = 10 Ω , $L_{\sigma}^{2)}$ =180nH, $C_{\sigma}^{2)}$ =39pF Energy losses include "tail" and diode reverse recovery. | - | 45 | - | |
| Turn-off delay time | $t_{d(off)}$ | | - | 600 | - | |
| Fall time | t _f | | - | 130 | - | |
| Turn-on energy | Eon | | - | 6.4 | - | mJ |
| Turn-off energy | E _{off} | | - | 9.4 | - | |
| Total switching energy | E _{ts} | | - | 15.8 | - | |

Power Semiconductors 3

 $^{^{2)}}$ Leakage inductance L_{σ} and $\,$ Stray capacity ${\it C}_{\sigma}$ due to dynamic test circuit in Figure E.





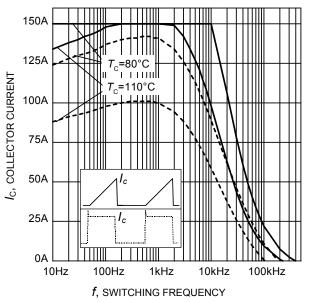


Figure 1. Collector current as a function of switching frequency $(T_{\rm j} \le 150^{\circ}{\rm C}, \, D=0.5, \, V_{\rm CE}=600{\rm V}, \, V_{\rm GE}=0/+15{\rm V}, \, R_{\rm G}=10\Omega)$

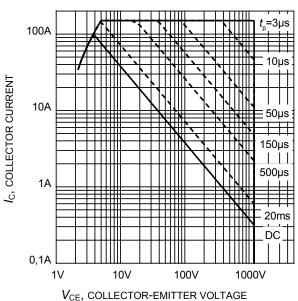


Figure 2. Safe operating area $(D = 0, T_C = 25^{\circ}C, T_i \le 150^{\circ}C; V_{GE} = 15V)$

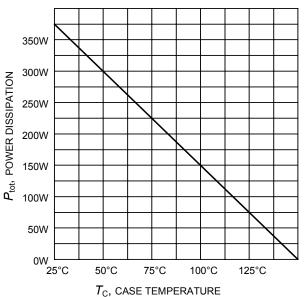


Figure 3. Power dissipation as a function of case temperature $(T_i \le 150^{\circ}\text{C})$

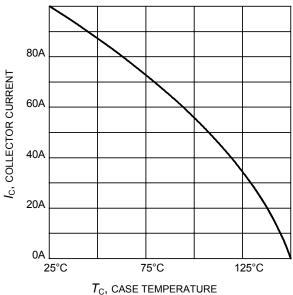


Figure 4. Collector current as a function of case temperature $(V_{GE} \ge 15V, T_i \le 150^{\circ}C)$



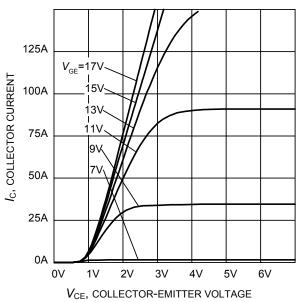


Figure 5. Typical output characteristic $(T_i = 25^{\circ}C)$

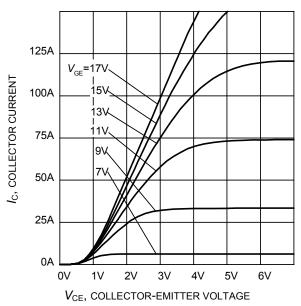


Figure 6. Typical output characteristic $(T_i = 150^{\circ}\text{C})$

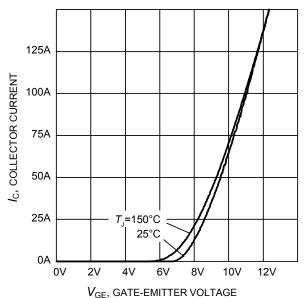


Figure 7. Typical transfer characteristic $(V_{CE}=20V)$

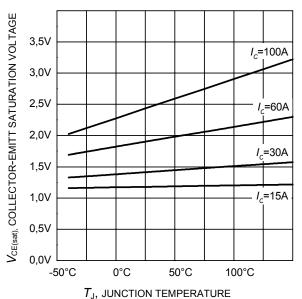


Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature $(V_{GE} = 15V)$



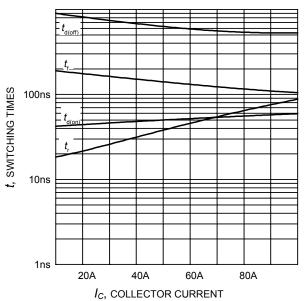


Figure 9. Typical switching times as a function of collector current (inductive load, T_J =150°C, V_{CE} =600V, V_{GE} =0/15V, R_G =10 Ω , Dynamic test circuit in Figure E)

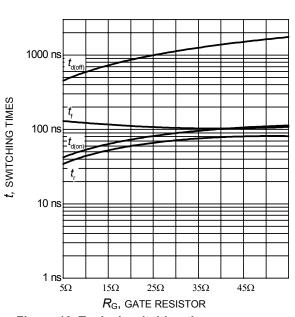


Figure 10. Typical switching times as a function of gate resistor (inductive load, T_J =150°C, V_{CE} =600V, V_{GE} =0/15V, I_C =60A, Dynamic test circuit in Figure E)

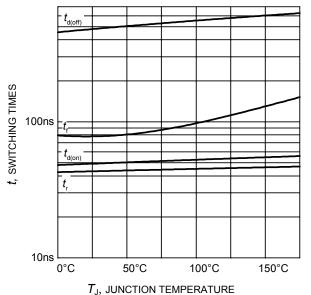


Figure 11. Typical switching times as a function of junction temperature (inductive load, V_{CE} =600V, V_{GE} =0/15V, I_{C} =60A, R_{G} =10 Ω , Dynamic test circuit in Figure E)

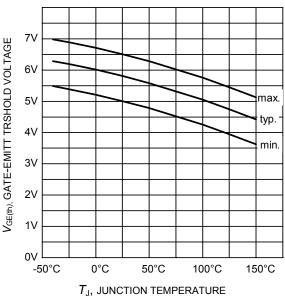


Figure 12. Gate-emitter threshold voltage as a function of junction temperature ($I_C = 2.0 \text{mA}$)



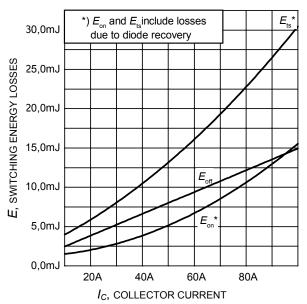


Figure 13. Typical switching energy losses as a function of collector current (inductive load, T_J =150°C, V_{CE} =600V, V_{GE} =0/15V, R_G =10 Ω , Dynamic test circuit in Figure E)

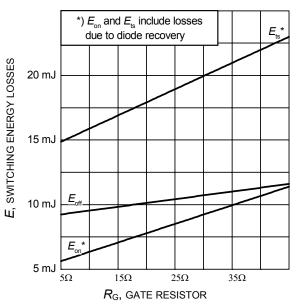


Figure 14. Typical switching energy losses as a function of gate resistor (inductive load, T_J =150°C, V_{CE} =600V, V_{GE} =0/15V, I_C =60A, Dynamic test circuit in Figure E)

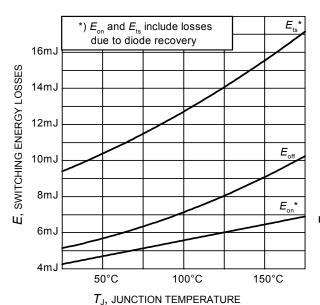
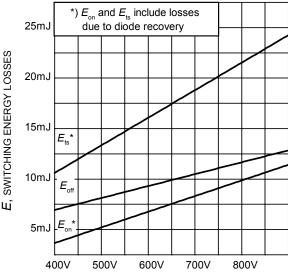


Figure 15. Typical switching energy losses as a function of junction temperature

(inductive load, $V_{\rm CE}$ =600V, $V_{\rm GE}$ =0/15V, $I_{\rm C}$ =60A, $R_{\rm G}$ =10 Ω , Dynamic test circuit in Figure E)



 $V_{\it CE}$, COLLECTOR-EMITTER VOLTAGE

Figure 16. Typical switching energy losses as a function of collector emitter voltage

(inductive load, $T_{\rm J}$ =150°C, $V_{\rm GE}$ =0/15V, $I_{\rm C}$ =60A, $R_{\rm G}$ =10 Ω , Dynamic test circuit in Figure E)



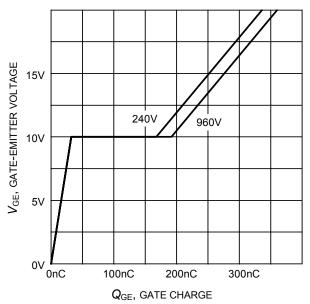
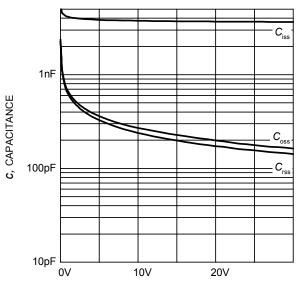


Figure 17. Typical gate charge $(I_C=60 \text{ A})$



 V_{CE} , COLLECTOR-EMITTER VOLTAGE

Figure 18. Typical capacitance as a function of collector-emitter voltage $(V_{GE}=0V, f=1 \text{ MHz})$

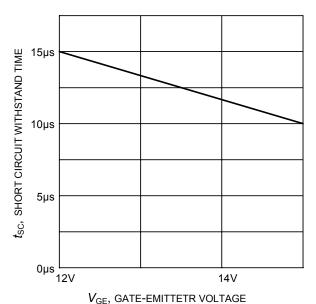
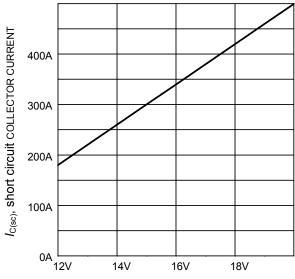


Figure 19. Short circuit withstand time as a function of gate-emitter voltage (V_{CE} =600V, start at T_{J} =25°C)



 $V_{\rm GE}$, gate-emittetr voltage

Figure 20. Typical short circuit collector current as a function of gate-emitter voltage $(V_{CE} \le 600\text{V}, T_i \le 150^{\circ}\text{C})$



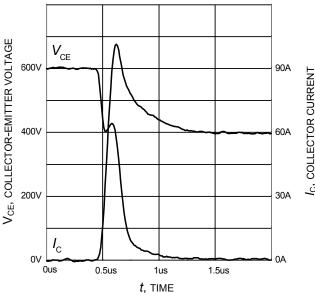


Figure 21. Typical turn on behavior $(V_{GE}=0/15V, R_{G}=10\Omega, T_{j}=150^{\circ}C, Dynamic test circuit in Figure E)$

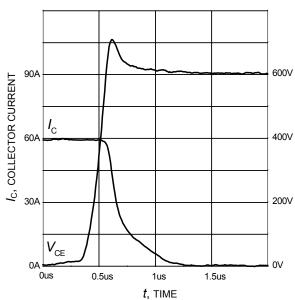


Figure 22. Typical turn off behavior $(V_{GE}=15/0V, R_{G}=10\Omega, T_{j}=150^{\circ}C, Dynamic test circuit in Figure E)$

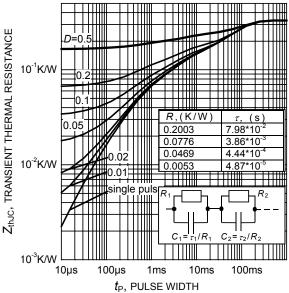
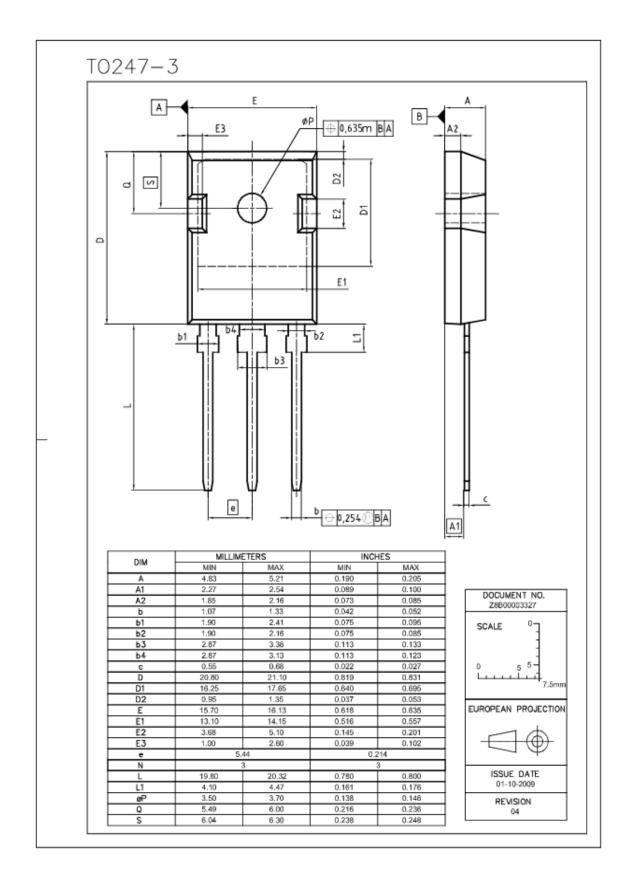


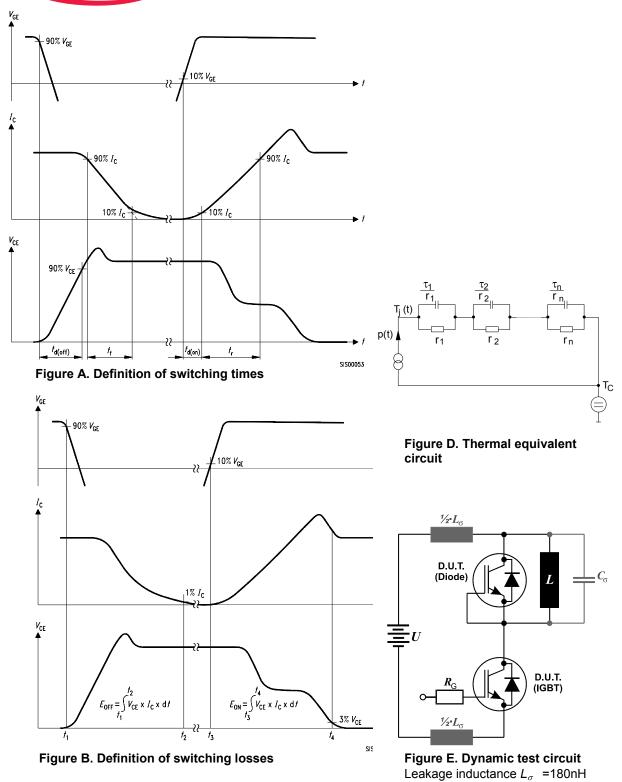
Figure 23. IGBT transient thermal resistance $(D = t_p / T)$

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and Stray capacity C_{σ} =39pF.

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TrenchStop® Series

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